

| BV _{DSS} | R _{DS(ON)} | I _D |
|-------------------|---------------------|----------------|
| 60 V | 3 Ω | 320 mA |

SOT-23

Features

- $R_{DS(ON)} \leq 3\Omega@V_{GS} = 10V$
- $R_{DS(ON)} \le 3.2 \Omega @V_{GS} = 4.5 V$
- High Density Cell Design For Ultra Low On-Resistance
- · Very Low Leakage Current In Off Condition
- ESD Protected 2KV HBM

Mechanical Data

Case : SOT-23Marking : K72

| Ordering Information | | | | |
|----------------------|--------------------|---------|--------------------|--|
| Part No. | Remark | Package | Packing | |
| TNMNG30H | RoHS Compliant | | | |
| TNMNG30H-H | Halogen Free | SOT-23 | 3000 / Tape & Reel | |
| TNMNG30H-Q | AEC-Q101 qualified | | | |

| Maximum Ratings (TA=25°C unless otherwise noted) | | | | |
|--|-----------------|---------|------|--|
| Parameter | Symbol | Limit | Unit | |
| Drain-Source Voltage | V_{DSS} | 60 | V | |
| Gate-Source Voltage | V_{GSS} | ±20 | V | |
| Continuous Drain | I _D | 320 | mA | |
| Pulsed Drain Current (NOTE 1) | I _{DM} | 2000 | mA | |
| Total Power Dissipation (NOTE 3) | P _D | 350 | mW | |
| Junction and Storage Temperature Range | T_J,T_STG | -55~150 | °C | |
| Typical Thermal Resistance | $R_{\theta JA}$ | 357 | °C/W | |

NOTE:

- 1.Maximum DC current limited by the package
- 2.Pulse test : pulse width \leq 300us, duty cycle \leq 2.0%.
- 3.1*MRP FR-4 PC board,2oz.





| Electrical Characteristics (TA=25°C unless otherwise noted) | | | | | | |
|---|--|---------------------|------|------|------|------|
| Parameter | Conditions | Symbol | Min. | Тур. | Max. | Unit |
| Static | | | | | | |
| Drain-source breakdown voltage | V_{GS} =0V, I_D =10 μ A | $V_{(BR)DSS}$ | 60 | - | - | V |
| Gate-threshold voltage | $V_{DS}=V_{GS}$, $I_{D}=250uA$ | $V_{GS(th)}$ | 1 | - | 2.1 | V |
| Drain-Source On-Resistance | V_{GS} =5V, I_D =50mA | | - | - | 2.8 | |
| | V_{GS} =4.5V, I_D =200mA | R _{DS(on)} | - | - | 3.2 | Ω |
| | V _{GS} =10V, I _D =500mA | | - | - | 3.0 | 1 |
| Zero gate voltage drain current | V _{DS} =60V, V _{GS} =0V | I _{DSS} | - | - | 1 | uA |
| Gate-source leakage current | V_{DS} =0V, V_{GS} =±20V | I _{GSS} | - | - | ±10 | uA |
| Forward Transconductance | V _{DS} =15V , I _D =250mA | gfs | - | 300 | - | mS |

Dynamic Characteristics

| Total Gate Charge | $V_{DS} = 15V, V_{GS} = 5V, I_{D} = 200 \text{mA}$ | Q_g | - | - | 0.8 | nC |
|------------------------------|---|--------------|---|----|-----|----|
| Delay Turn-On Time | V_{DD} =30V, R_L =150 Ω , I_D =200mA , | $t_{d(on)}$ | - | 6 | - | ne |
| Delay Turn-Off Time | V_{GEN} =10V, R_{G} =10 Ω | $t_{d(off)}$ | - | 13 | - | ns |
| Input capacitance | | Ciss | - | - | 35 | |
| Output capacitance | $V_{DS} = 25V, V_{GS} = 0V, f = 1MHz$ | Coss | - | - | 12 | pF |
| Reverse transfer capacitance | | Crss | - | - | 7 | |

Source-Drain Diode

| Diode Forward Voltage | V_{GS} =0V , I_{S} =200mA | V _{SD} | - | 0.82 | 1.1 | V |
|---------------------------|---|-----------------|---|-------|-----|----|
| Continuous Source Current | | I _S | - | - | 300 | mA |
| Reverse Recovery Time | V_{GS} =0V, V_{DD} =30V, I_{S} =1A, | t _{rr} | - | 16.42 | - | nS |
| Reverse Recovery Charge | dls/dt=100A/us | Q_{rr} | - | 9.02 | - | nC |





Characteristics Curves

FIG. 1-Output Characteristics

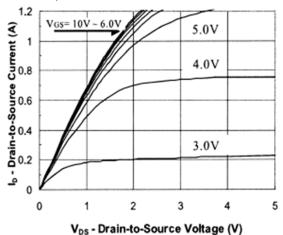


FIG. 3-On-Resistance VS. Drain Current

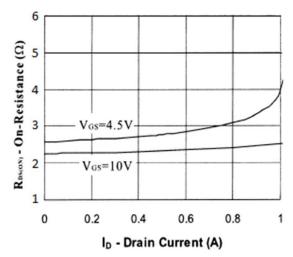


FIG. 5-On-Resistance VS. Junction Temperature

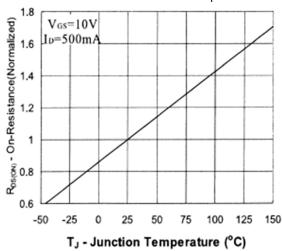


FIG. 2-Breakdown Voltage VS. Junction Temperature

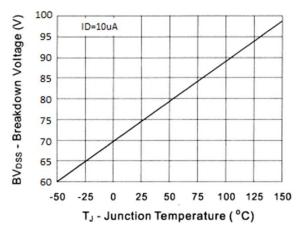


FIG. 4-On-Resistance VS. Gate-Source voltage

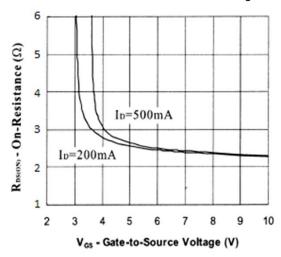
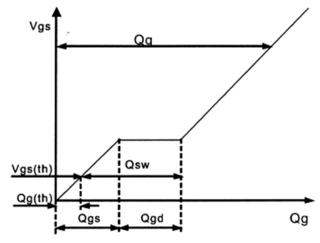


FIG. 6-Gate Charge Waveform







Characteristics Curves

FIG. 7-Gate Charge

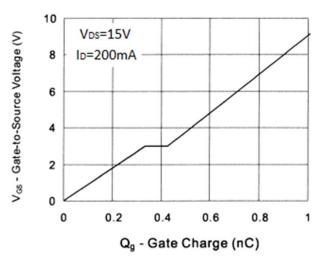


FIG. 9-Capacitance VS. Drain to Source Voltage

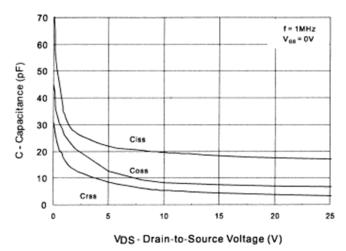


FIG. 11-QRR and TRR Waveform definitions

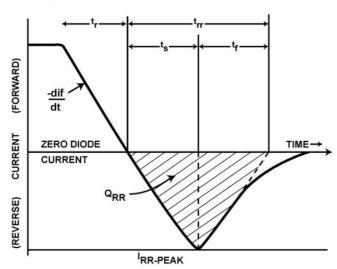


FIG. 8-Threshold Voltage VS. Temperature

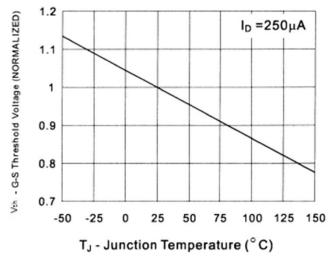
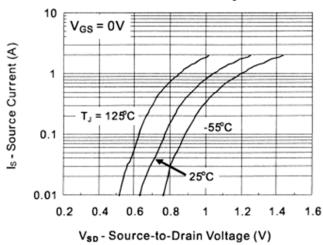


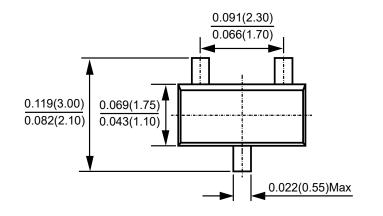
FIG. 10-Source-Drain Diode Forward Voltage

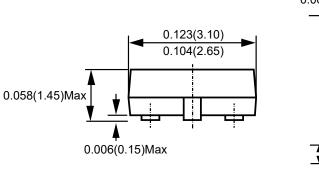


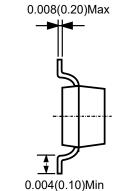




Package Outline Dimensions

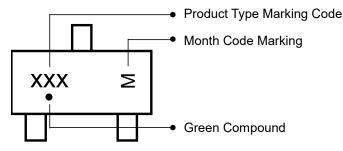






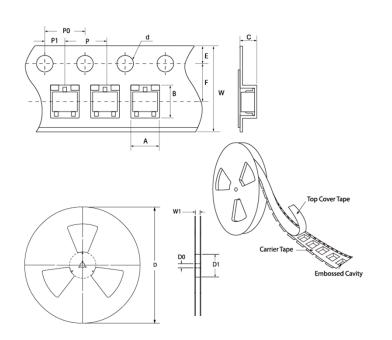
SOT-23Dimensions in inches and (millimeters)

Marking Information



| Suggested Pad Layout | | | | | |
|----------------------|-------------|--|--|--|--|
| Outline | SOT-23 | | | | |
| Symbol | millimeters | F → | | | |
| Α | 2.90 | ▎▕ ▕ ᡶᢩᡶ┼╶ ┆ ╴ᡶᢩᡶ╂┰ | | | |
| С | 0.80 | | | | |
| D | 0.90 | l ï <u>↓ </u> | | | |
| E | 2.00 | D ++ | | | |
| F | 1.35 | ↑ → c ← | | | |

| Tape & Reel Specification | | | | | |
|---------------------------|--------|----------------|--|--|--|
| Item | Symbol | SOT-23 (mm) | | | |
| Carrier width | А | 3.15 ± 0.25 | | | |
| Carrier length | В | 2.95 ± 0.35 | | | |
| Carrier depth | С | 1.35 ± 0.25 | | | |
| Sprocket hole | d | 1.50 ± 0.1 | | | |
| Reel outside diameter | D | 178.0 ± 2.0 | | | |
| Reel inner diameter | D1 | 50 (min) | | | |
| Feed hole diameter | D0 | 13.0 ± 1.0 | | | |
| Sprocket hole position | E | 1.75 ±0.1 | | | |
| Punch hole position | F | 3.50 ± 0.1 | | | |
| Punch hole pitch | Р | 4.00 ± 0.1 | | | |
| Sprocket hole pitch | P0 | 4.00 ± 0.1 | | | |
| Embossment center | P1 | 2.00 ± 0.1 | | | |
| Tape width | W | 8.00 ± 0.3 | | | |
| Reel width | W1 | 9.50 ± 1.5 | | | |







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